Model: FXO-HC73 SERIES

HCMOS 7 x 5mm 3.3V Oscillator

Freq: 0.75 MHz to 250MHz

Rev. 11/28/2007

Features

- XTREMELY Low Jitter
- Low Cost
- XPRESS Delivery
- Frequency Resolution to six decimal places
- Stabilities to ± 20 PPM
- -20 to +70°C or -40 to +85°C operating temperatures
- Tri-State Enable / Disable Feature
- Industry Standard Package, Footprint & Pin-Out
- Fully RoHS compliant
- Gold over Nickel Termination Finish
- Serial ID with Comprehensive Traceability
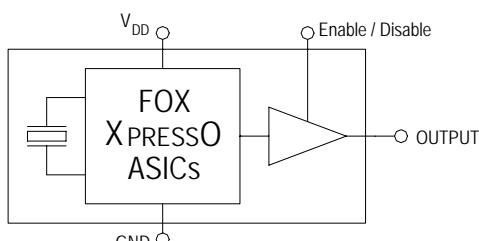
For more information -- Click on the drawing

Applications

- ANY application requiring an oscillator
- SONET
- Ethernet
- Storage Area Network
- Broadband Access
- Microprocessors / DSP / FPGA
- Industrial Controllers
- Test and Measurement Equipment
- Fiber Channel

Description

The Fox XPRESSO Crystal Oscillator is a breakthrough in configurable Frequency Control Solutions.   XPRESSO utilizes a family of proprietary ASICs, designed and developed by Fox, with a key focus on noise reduction technologies.

The 3rd order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. The ASICs family has ability to select the output type, input voltages, and temperature performance features.

With the XPRESS lead-time, low cost, low noise, wide frequency range, excellent ambient performance, XpressO is an excellent choice over the conventional technologies.

Finished XPRESSO parts are 100% final tested.

Contents

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

Model Selection Guide & Fox Part Number

STEP #1: Customer selects the Model Description and provides to Fox Customer Service

Model Description

F X O – H C 7 3 6 R – 1 0 6 . 2 5   Frequency (in MHz)
Resolutions to 6 places
past the decimal point

H = HCMOS	**C** = Ceramic	**5** = 5 x 3.2mm	**3** = 3.3 V	**0** = ± 100 PPM	***blank*** = -20°C to +70°C
L = LVDS	**Q** = Quartz	**7** = 7 x 5mm	**2** = 2.5 V	**5** = ± 50 PPM	**R** = -40°C to +85°C
P = LVPECL				**6** = ± 25 PPM	
M = LVDS *(pin 2 E/D)*				**8** = ± 20 PPM	
Q = LVPECL *(pin 2 E/D)*				(-20 ~ +70°C)	
X = HCMOS *(comp 2nd Output)*					
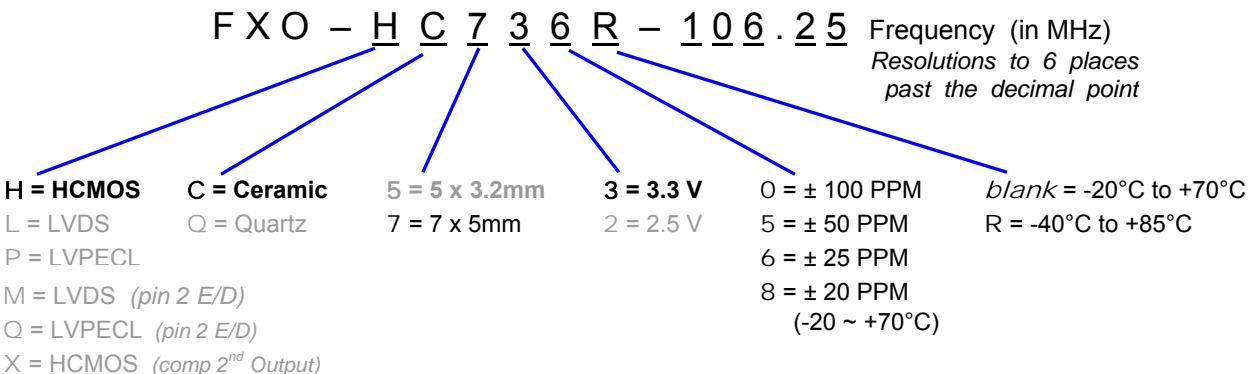
STEP #2: The Fox Customer Service team provides a customer specific Part Number
for use on their Bill Of Materials (BOM).

Fox Part Number *(The assigned Fox Part Number must be on the BOM – not the above Model Description)*
(This will ensure receipt of the proper part)

The 1st Field
Product Code #
767 = FXO–HC5
768 = FXO–HC7
770 = FXO–LC5
771 = FXO–LC7
773 = FXO–PC5
774 = FXO–PC7

7 6 8 – 1 0 6 . 2 5 – 2 0

The 3rd Field
Fox Internally Generated Number
(If any specification changes,
the last digits change)
(The same specs for a different customer
also changes the last digits)

The 2nd Field
The Customer's Frequency
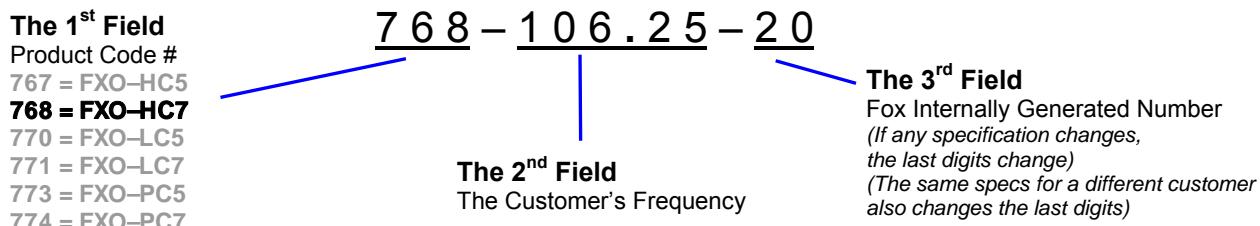
This example, **FXO-HC736R-106.25** = HCMOS Output, Ceramic 7 x 5mm Package, 3.3V,
±25 PPM Stability, -40 to +85°C Temperature Range, at 106.25 MHz

Electrical Characteristics

Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)
Frequency Range	F_O		0.750 to 250.000 MHz
Frequency Stability [1]			100, 50, 25, & 20 ppm
Temperature Range	T_O	Standard operating	-20°C to +70°C
		Optional operating	*-40°C to +85°C*
	T_{STG}	Storage	-55°C to +125°C
Supply Voltage	V_{DD}	Standard	3.3 V ± 5%
Input Current (@ 15pF LOAD)	I_{DD}	0.75 ~ 20 MHz	32 mA
		20+ ~ 50 MHz	35 mA
		50+ ~ 130 MHz	47 mA
		130+ ~ 200 MHz	55 mA
		200+ ~ 250 MHz	60 mA
Output Load	HCMOS	Standard	15 pF
		Operational To 125MHz	30 pF
Start-Up Time	T_S		10 mS
Output Enable / Disable Time			100 nS
Moisture Sensitivity Level	MSL	*JEDEC J-STD-20*	1
Termination Finish			Au

Note 1 – Stability is inclusive of 25°C tolerance, operating temperature range, input voltage change, load change, aging, shock and vibration.

This part is no longer available from Fox, please contact IDT for this product.

Absolute Maximum Ratings *(Useful life may be impaired. For user guidelines only, not tested)*

Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)
Input Voltage	V_{DD}		−0.5V to +5.0V
Operating Temperature	T_{AMAX}		−55°C to +105°C
Storage Temperature	T_{STG}		−55°C to +125°C
Junction Temperature			150°C
ESD Sensitivity	HBM	Human Body Model	1 kV

Output Wave Characteristics

| Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)
Output LOW Voltage	V_{OL}	0.75 to 150 MHz 150+ to 250 MHz	10% V_{DD} 20% V_{DD}
Output HIGH Voltage	V_{OH}	0.75 to 150 MHz 150+ to 250 MHz	90% V_{DD} MIN 80% V_{DD} MIN
Output Symmetry (See Drawing Below)		@ 50% V_{DD} Level	45% ~ 55%
Output Enable (PIN # 1) Voltage	V_{IH}		≥70% V_{DD}
Output Disable (PIN # 1) Voltage	V_{IL}		≤ 30% V_{DD}
Cycle Rise Time (See Drawing Below)	T_R	0.75 to 150 MHz 150+ to 250 MHz	3 nS (10%~90%) 3 nS (20%~80%)
Cycle Fall Time (See Drawing Below)	T_F	0.75 to 150 MHz 150+ to 250 MHz	3 nS (90%~10%) 3 nS (80%~20%)

If 30% to 70% times are used, Rise and Fall times change to 1.5 nS from 0.75 to 250MHz
If 20% to 80% times are used, Rise and Fall times change to 2 nS from 0.75 to 150MHz

Rise Time / Fall Time Measurements
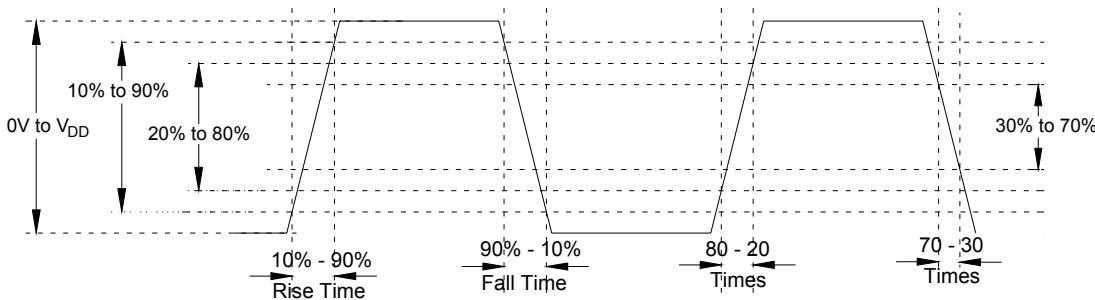
Oscillator Symmetry
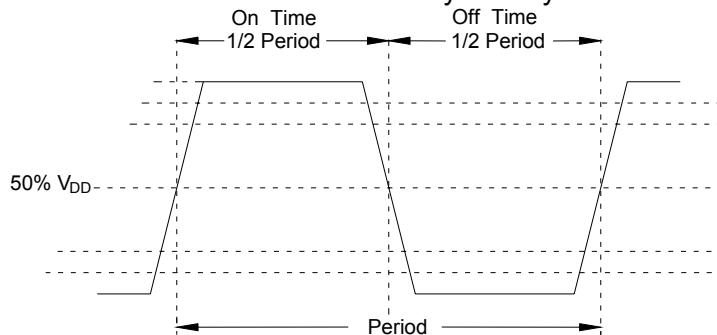
Ideally, Symmetry should be 50/50 -- Other expressions are 45/55 or 55/45

Phase Noise

Phase Noise Graph
(dBc / Hz) vs. offset frequency

Data Collected using HP 3048A
Three Frequencies from Jitter Tables
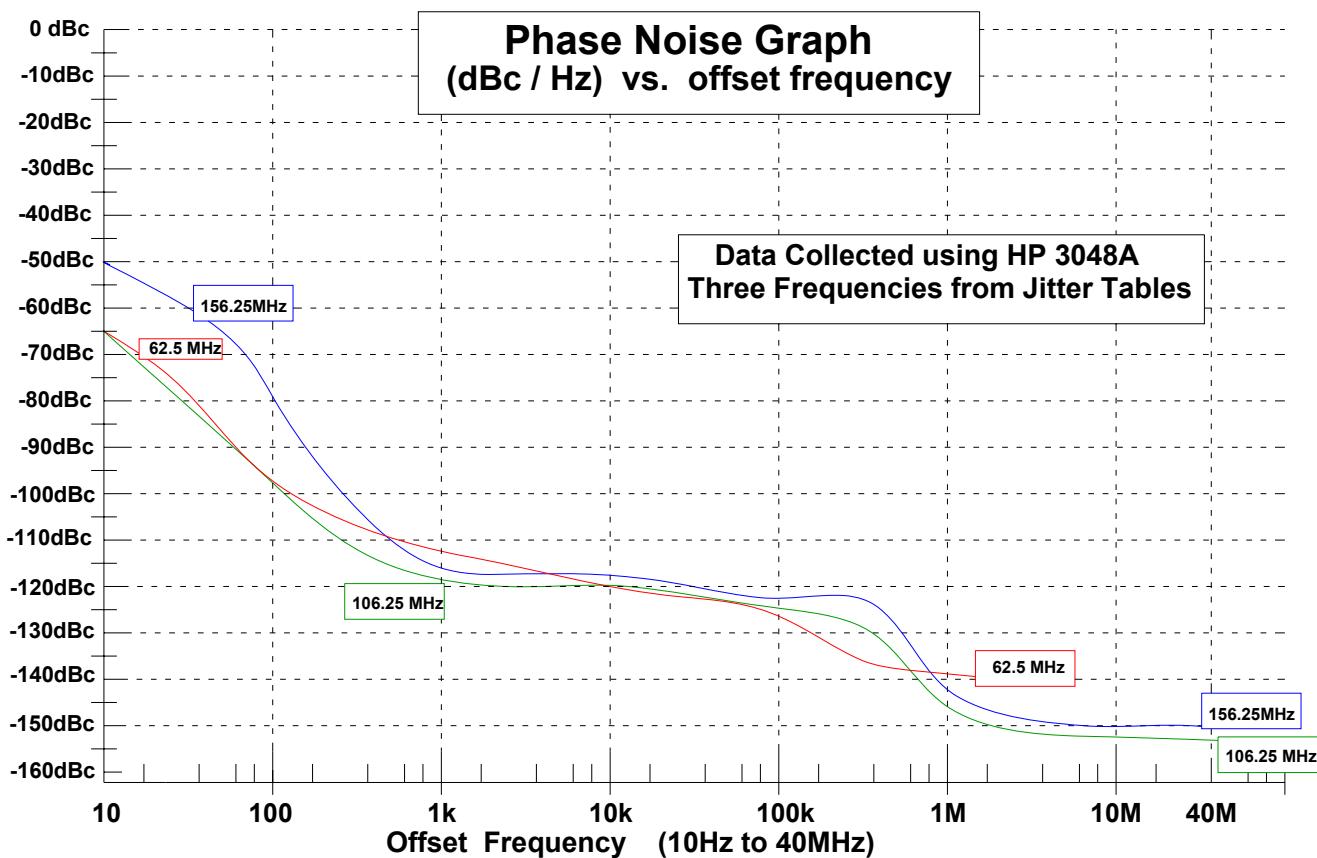
Jitter is frequency dependent. Below are typical values at select frequencies.

Phase Jitter & Time Interval Error (TIE)

Frequency	Phase Jitter (12kHz to 20MHz)	T I E (Sigma of Jitter Distribution)	Units
62.5 MHz	0.93	2.8	pS RMS
106.25 MHz	0.86	3.2	pS RMS
125 MHz	0.75	2.7	pS RMS
156.25 MHz	0.77	3.3	pS RMS

Phase Jitter is integrated from HP3048 Phase Noise Measurement System; measured directly into 50 ohm input; V_{DD} = 3.3V.
TIE was measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software; V_{DD} = 3.3V.
*Per **MJSQ** spec (Methodologies for Jitter and Signal Quality specifications)*

Random & Deterministic Jitter Composition

Frequency	Random (Rj) (pS RMS)	Deterministic (Dj) (pS P-P)	Total Jitter (Tj) (14 x Rj) + Dj
62.5 MHz	1.28	6.8	25.1 pS
106.25 MHz	1.28	8.4	26.6 pS
125 MHz	1.20	8.0	25.2 pS
156.25 MHz	1.27	8.6	26.6 pS

Rj and Dj, measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software.
*Per **MJSQ** spec (Methodologies for Jitter and Signal Quality specifications)*

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

Pin Description and Recommended Circuit

Pin #	Name	Type	Function
1	E / D [1]	Logic	Enable / Disable Control of Output (0 = Disabled)
2	GND	Ground	Electrical Ground for V_{DD}
3	Output	Output	HCMOS Oscillator Output
4	V_{DD} [2]	Power	Power Supply Source Voltage
Test Points	N. C.	Hi Z	No Connection (Factory Use ONLY)

NOTES:

[1] Includes pull-up resistor to V_{DD} to provide output when the pin (1) is No Connect.

[2] Installation should include a 0.01µF bypass capacitor placed between V_{DD} (Pin 4) and GND (Pin 2) to minimize power supply line noise.
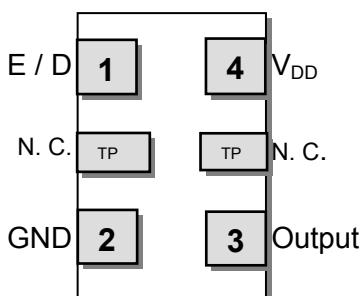

Terminations as viewed from the Top

**NOTE:** XPRESSO HCMOS XOs are designed to fit on Industry Standard, 4 pad layouts
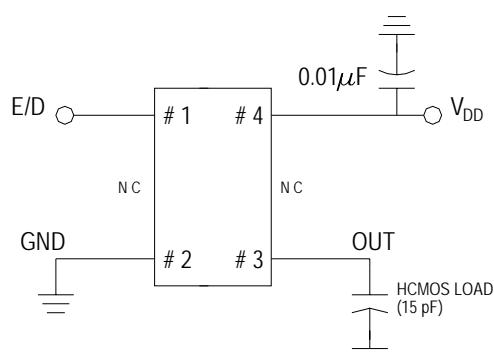
Enable / Disable Control

	Pin # 1 (state)	Output (Pin # 3)
	OPEN (No Connection)	ACTIVE Output
	"1" Level $V_{IH} > 70\%\ V_{DD}$	ACTIVE Output
	"0" Level $V_{IL} < 30\%\ V_{DD}$	High Impedance

## Soldering Reflow Profile (2 times Maximum at 260°C for 10 seconds MAX)

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series
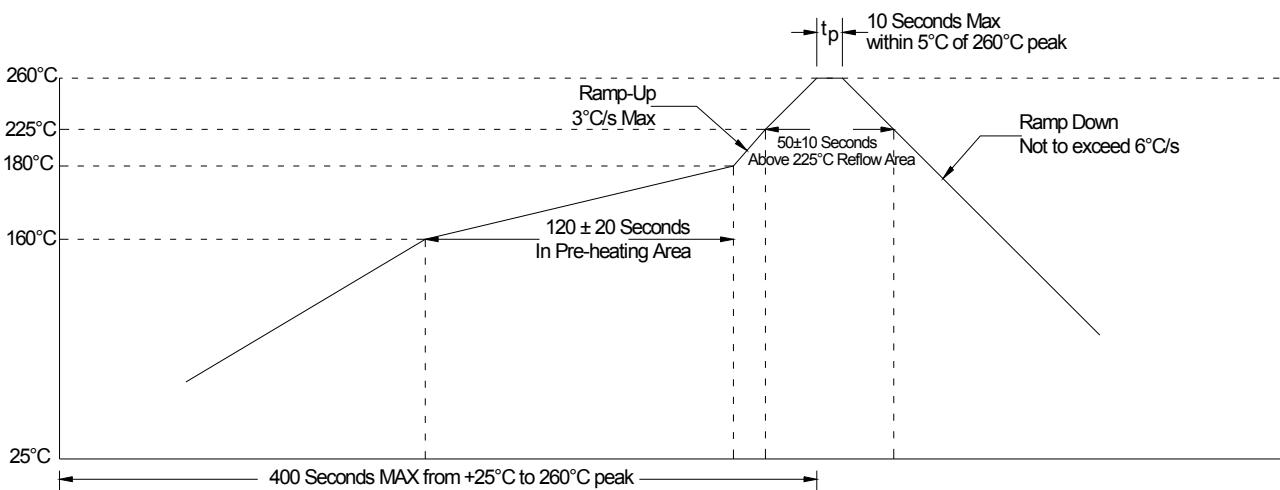
Mechanical Dimensional Drawing & Pad Layout

7.5 Max

#4   #3

Top
View

X PRESS O

5.2 Max

#1   #2

Pin 1 Designator
(FOX Head or Dot)
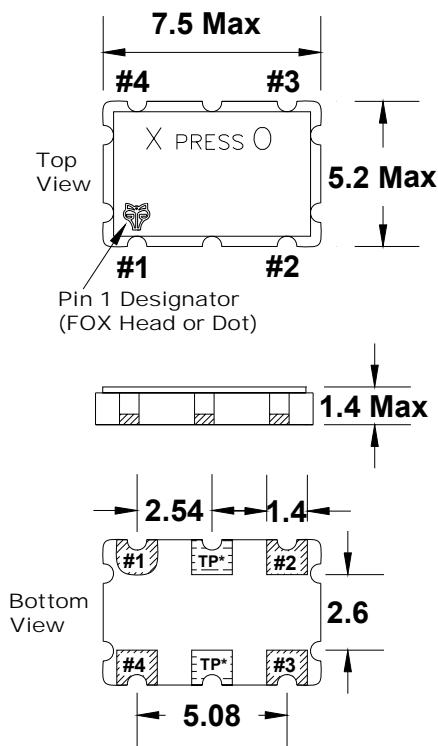
Actual part marking
is depicted.

See **Traceability** *(pg. 8)*
for more information

1.4 Max

2.54   1.4

Bottom
View

#1   TP*   #2

2.6

#4   TP*   #3

5.08

Recommended Solder Pad Layout

5.08

2.0

4.2

1.8
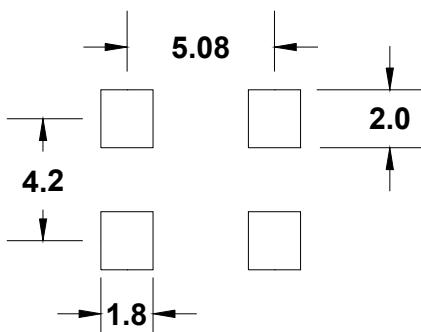
Note: XPRESSO HCMOS XOs are designed to fit on
industry standard, 4 pad, layouts.

Pin Connections
#1) E/D   #3 Output
#2 GND   #4 VDD
*TP are test points and are NC

Drawing is for reference to critical specifications defined by size measurements.
Certain non-critical visual attributes, such as side castellations, reference pin shape, etc. may vary

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

Tape and Reel Dimensions
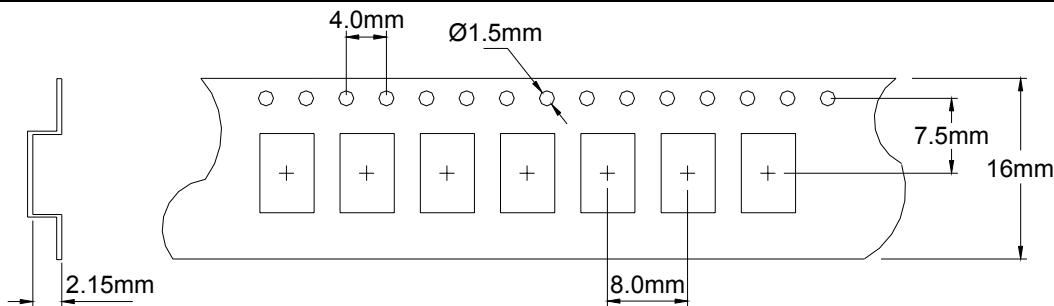
## 1k Reel Dimensions in mm

2k Reel Dimensions in mm
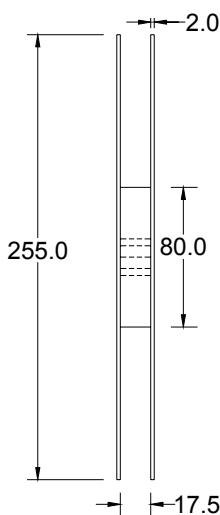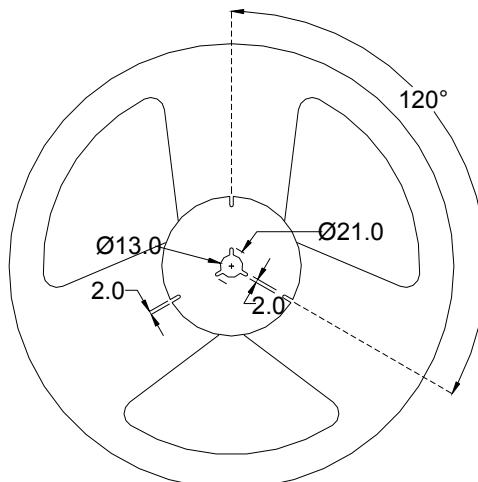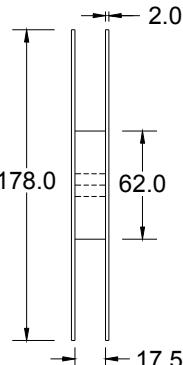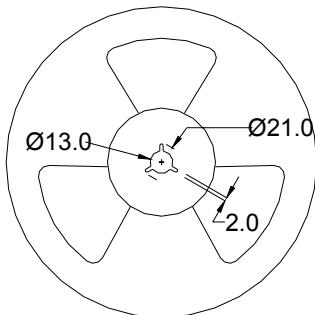
Labeling   (Reels and smaller packaging are labeled with the below)

- Fox Part Number: **768-106.25-20**
- Quantity: **2000** pieces
- Description: **FXO-HC736R-106.25**
- Date Code   **0745**
  (YYWW 2007 45th wk)
- LOT #   **24435**
  If traceability should become necessary

An additional identification code is contained internally if tracking should ever be necessary

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

Traceability – LOT Number & Serial Identification

LOT Number

The LOT Number has direct ties to the customer purchase order. The LOT Number is marked on the "Reel" label, and also stored internally on non-volatile memory inside the XPRESSO part. XPRESSO parts that are shipped Tape and Reel, are also placed in an Electro Static Discharge (ESD) bag and will have the LOT Number labeled on the exterior of the ESD bag.

It is recommended that the XPRESSO parts remain in this ESD bag during storage for protection and identification.

If the parts become separated from the label showing the LOT Number, it can be retrieved from inside one of the parts, and the information that can be obtained is listed below:

- Customer Purchase Order Number
- Internal Fox Sales Order Number
- Dates that the XPRESSO part was shipped from the factory
- The assigned customer part number
- The specification that the part was designed for

Serial Identification

The Serial ID is the individualized information about the configuration of that particular XPRESSO part. The Serial ID is unique for each and every XPRESSO part, and can be read by special Fox equipment.

With the Serial ID, the below information can be obtained about that individual, XPRESSO part:

- Equipment that the XPRESSO part was configured on
- Raw material used to configure the XPRESSO part
- Traceability of the raw material back to the foundries manufacturing lot
- Date and Time that the part was configured
- Any optimized electrical parameters based on customer specifications
- Electrical testing of the actual completed part
- Human resource that was monitoring the configuration of the part

Fox has equipment placed at key Fox locations World Wide to read the Lot Identification and Serial Number of any XPRESSO part produced and can then obtain the information from above within 24 hours

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

RoHS Material Declaration

	Material Name	Component	Content (mg)	Content (wt%)	(CAS Number)
Cover	Kovar	Nickel (Ni)	5.09	3.63%	7440-02-0
		Cobalt (Co)	3.15	2.24%	7440-48-4
		Iron (Fe)	9.47	6.75%	7439-89-6
Base	Ceramic	Alumina (Al_2O_3)	79.178	56.4%	1344-28-1
		Silicon Oxide (SiO_2)	3.143	2.24%	14808-60-7
		Chromium Oxide (Cr_2O_3)	3.379	2.41%	1308-38-9
		Titanium Oxide (TiO_2)	0.873	0.622%	13463-67-7
		Magnesium Oxide (MgO)	0.437	0.311%	1309-48-4
		Calcium Oxide (CaO)	0.297	0.212%	1305-78-8
	+ Metallization	Tungsten (W)	12.272	8.74%	7440-33-7
		Molybdenum (Mo)	0.380	0.27%	7439-98-7
	+ Nickel Plating	Nickel (Ni)	4.740	3.38%	7440-02-0
		Cobalt (Co)	0.395	0.28%	7440-48-4
	+ Gold Plating	Gold (Au)	0.624	0.445%	7440-57-5
	＋Seal ring	Iron (Fe)	5.809	4.14%	7439-89-6
		Nickel (Ni)	3.119	2.22%	7440-02-0
		Cobalt (Co)	1.829	1.30%	7440-48-4
	＋silver solder	Silver (Ag)	2.269	1.62%	7440-22-4
		Copper (Cu)	0.400	0.285%	7440-50-8
ＩＣ	ＩＣ	Aluminum (Al)	0.0021	0.00150%	7429-90-5
		Silicon (Si)	0.950	0.68%	7440-21-3
	Gold	Gold (Au)	0.480	0.342%	7440-57-5
	Adhesive	Silver (Ag)	0.000210	0.000150%	7440-22-4
		Epoxy	0.0000700	0.0000499%	
Crystal	Crystal	Silicon Dioxide (SiO_2)	2.04	1.45%	14808-60-7
	Electrode	Silver (Ag)	0.019	0.0135%	7440-22-4
		Nickel (Ni)	0.000159	0.000113%	7440-02-0
	Adhesive	Silver (Ag)	0.00037	0.000264%	7440-22-4
		Silicon (Si)	0.000125	0.000089%	7440-21-3
TOTAL			**140.3**	**100.00%**	

XPRESSO

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

3rd Party (SGS) Material Report

SGS

Test Report

No. 2053204/EC   Date : Mar 01 2006   Page 1 of 2

FOX ELECTRONICS
5570 ENTERPRISE PARKWAY
FT. MYERS, FL 33905

Report on the submitted sample said to be CERAMIC SEAM SEAL OSCILLATOR.

SGS Job No.   :   1981176
Supplier / Manufacturer   :   FOX ELECTRONICS
Sample Receiving Date   :   FEB 17 2006
Testing Period   :   FEB 18 - 24 2006

Test Requested :   1)   To determine the Cadmium Content in the submitted sample.
                       2)   To determine the Lead Content in the submitted sample.
                       3)   To determine the Mercury Content in the submitted sample.
                       4)   To determine the Hexavalent Chromium Content on the submitted sample.
                       5)   To determine PBBs (polybrominated biphenyls) and PBDEs
                               (Polybrominated diphenylethers) of the submitted sample.

Test Method   :   1-3)   With reference to EPA Method 3051/ 3052.
                               Analysis was performed by Inductively Coupled Argon Plasma-Atomic
                               Emission Spectrometry (ICP-AES).
                       4)   With reference to EPA Method 3060A & 7196A.
                               The sample was alkaline digested by using EPA Method 3060A, and then
                               analyzed by using Colorimetric method 7196A (by UV-Vis
                               Spectrophotometer).
                       5)   With reference to EPA Method 3540C/ 3550C. Analysis was performed by
                               GC/MS or LC/ MS.

Test Results   :   1-5)   Please refer to next page.

Signed for and on behalf of
SGS Hong Kong Ltd
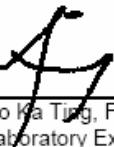
Ho Ka Ting, Family
Laboratory Executive

SGS Hong Kong Ltd. 5/F - 8/F & 28/F -29/F, Metropole Square, 2 On Yiu Street, Siu Lek Yuen, Shatin, N.T., Hong Kong. t (852) 2334 4481-9 f (852) 2764 3126 www.hk.sgs.com
Member of the SGS Group (SGS SA)

XPRESSO

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

3rd Party (SGS) Material Report (continued)

SGS

Test Report   No. 2053204/EC   Date : Mar 01 2006   Page 2 of 2

Test Results   :

Test Item	1	Detection Limit
1) Cadmium (Cd)	ND	2 ppm
2) Lead (Pb)	ND	2 ppm
3) Mercury (Hg)	ND	2 ppm
4) Hexavalent Chromium (Cr^{6+})	ND	2 ppm

(Results shown are of the total weight of samples)

Note :   ppm = mg/kg
ND = Not Detected
Not detected is reported when the reading is less than detection limit value

5)

Flame Retardants	1	Detection Limit
Polybrominated Biphenyls (PBBs)	---	---
Monobromobiphenyl	ND	5 ppm
Dibromobiphenyl	ND	5 ppm
Tribromobiphenyl	ND	5 ppm
Tetrabromobiphenyl	ND	5 ppm
Pentabromobiphenyl	ND	5 ppm
Hexabromobiphenyl	ND	5 ppm
Heptabromobiphenyl	ND	5 ppm
Octabromobiphenyl	ND	5 ppm
Nonabromobiphenyl	ND	5 ppm
Decabromobiphenyl	ND	5 ppm
Polybrominated Diphenylethers (PBDEs)	---	---
Monobromodiphenyl ether	ND	5 ppm
Dibromodiphenyl ether	ND	5 ppm
Tribromodiphenyl ether	ND	5 ppm
Tetrabromodiphenyl ether	ND	5 ppm
Pentabromodiphenyl ether	ND	5 ppm
Hexabromodiphenyl ether	ND	5 ppm
Heptabromodiphenyl ether	ND	5 ppm
Octabromodiphenyl ether	ND	5 ppm
Nonabromodiphenyl ether	ND	5 ppm
Decabromodiphenyl ether	ND	5 ppm

Note   :   ppm = mg/kg
ND = Not Detected
Not detected is reported when the reading is less than detection limit value.

Sample Description:
1. Black Ceramic w/ Silvery, Golden Metal w/ Silvery Chips

*** End of Report ***

FOX

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

Mechanical Testing

Parameter	Test Method
Mechanical Shock	Drop from 75cm to hardwood surface – 3 times
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 Minute Sweep 2 Hours each in 3 Directions (X, Y, Z)
High Temperature Burn-in	Under Power @ 125°C for 2000 Hours (results below)
Hermetic Seal	He pressure: 4 ±1 kgf / cm^2 2 Hour soak

2,000 Hour Burn-In

Burn-In Testing – under power 2000 Hours, 125°C

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series
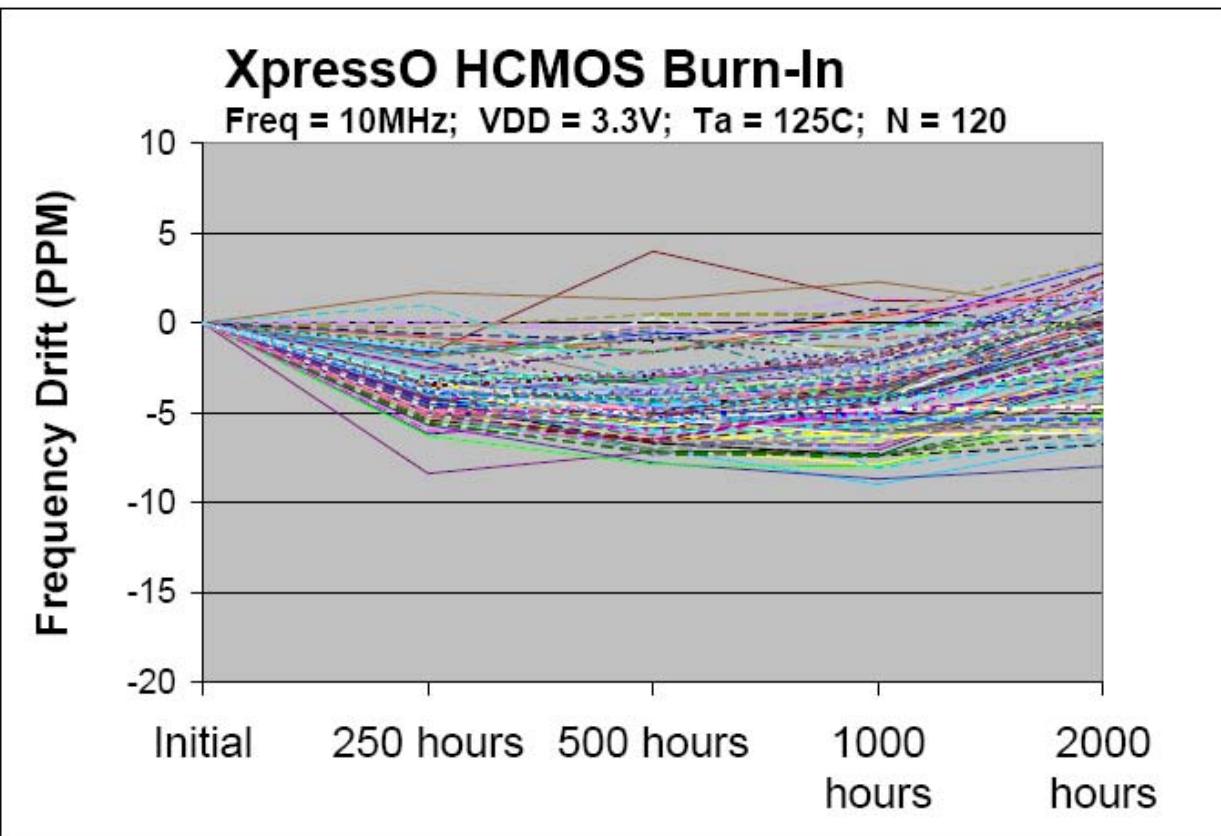
MTTF / FITS Calculations

Products are grouped together by process for MTTF calculations.
(All XpressO output and package types are manufactured with the same process)

Number of Parts Tested: 360 (120 of each output type: HCMOS, LVDS, LVPECL)
Number of Failures: 0
Test Temperature: 125°C
Number of Hours: 2000

MTTF was calculated using the following formulas:

[1.] Device Hours (*devhrs*) = (number of devices) x (hours at elevated temperature in °K)

$$[2.] \quad MTTF = \frac{devhrs \times af \times 2}{\chi^2}$$

$$[3.] \quad FITS = \frac{1}{MTTF} * 10^9$$

Where:

Label	Name	Formula/Value
af	Acceleration Factor	$e^{(\frac{eV}{k}) \times (\frac{1}{t_1} - \frac{1}{t_2})}$
eV	Activation Energy	0.40 V
k	Bolzman's Constant	8.62×10^{-5} eV/°K
t_1		Operating Temperature (°K)
t_2		Accelerated Temperature (°K)
Θ	Theta	Confidence Level (60% industry standard)
r	Failures	Number of failed devices
χ^2	Chi-Square	statistical significance for bivariate tabular analysis [table look-up] based on assumed Θ (Theta – confidence) and number of failures (r) For zero failures (60% Confidence): χ^2 = 1.830

DEVICE-HOURS = 360 x 2000 HOURS = 720,000

ACCELERATION FACTOR = $e^{(\frac{0.40}{8.625}) \times (\frac{1}{298} - \frac{1}{398})}$ = 49.91009

MTTF = $\frac{720,000 \times 49.91009 \times 2}{1.833}$ = 15,607,065 Hours

Failure Rate = $\frac{1.833}{720,000 \times 49.91009 \times 2}$ = 6.41E-8

FITS = Failure Rate *1E9 = 64

This part is no longer available from Fox, please contact IDT for this product.

FXO-HC73 Series

Notes :

Contact Information

(USA)-Worldwide Headquarters
Tel: 888-GET-2-FOX
Outside US: +1.239.693.0099,
Fax:+1.239.693.1554
Email: www.foxonline.com/email.htm

Fox EMEA
Tel/Fax: +44 1283 568153
Email: www.foxonline.com/email.htm

Fox Japan
Tel:+81.3.3374.2079,
Fax: +81.3.3377.5221
Email: www.foxonline.com/email.htm

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ABRACON:

FXO-HC735-33.333 FXO-HC738-100-106 FXO-HC730-100-106 FXO-HC736-100-106 FXO-HC736R-125-149
FXO-HC736R-70-79 FXO-HC730R-70-79 FXO-HC735R-70-79 FXO-HC735R-125-149 FXO-HC735-70-79 FXO-HC736-70-79 FXO-HC730-70-79 FXO-HC735R-1-59 FXO-HC730R-1-59 FXO-HC735-125-149 FXO-HC730R-106-124 FXO-HC736R-1-59 FXO-HC735-200-250 FXO-HC735-90-99 FXO-HC736-90-99 FXO-HC730-90-99 FXO-HC735-100-106 FXO-HC736R-150-169 FXO-HC735R-100-106 FXO-HC738-80-89 FXO-HC736R-106-124 FXO-HC730R-60-69 FXO-HC730R-150-169 FXO-HC736R-60-69 FXO-HC735R-60-69 FXO-HC735-170-199 FXO-HC738-90-99 FXO-HC736-170-199 FXO-HC738-170-199 FXO-HC730-170-199 FXO-HC736-1-59 FXO-HC736R-80-89 FXO-HC730R-80-89 FXO-HC735R-80-89 FXO-HC730R-125-149 FXO-HC735R-170-199 FXO-HC738-70-79 FXO-HC738-1-59 FXO-HC735R-150-169 FXO-HC735-150-169 FXO-HC738-106-124 FXO-HC736-106-124 FXO-HC735-106-124 FXO-HC736R-170-199 FXO-HC730-106-124 FXO-HC736-150-169 FXO-HC730R-200-250 FXO-HC738-150-169 FXO-HC730-150-169 FXO-HC735-80-89 FXO-HC736-80-89 FXO-HC730-80-89 FXO-HC730-1-59 FXO-HC738-125-149 FXO-HC730-125-149 FXO-HC730R-100-106 FXO-HC736-125-149 FXO-HC738-200-250 FXO-HC738-60-69 FXO-HC735R-200-250 FXO-HC736-200-250 FXO-HC735-1-59 FXO-HC736R-200-250 FXO-HC730-200-250 FXO-HC730R-170-199 FXO-HC735R-106-124 FXO-HC736-60-69 FXO-HC736R-90-99 FXO-HC730R-90-99 FXO-HC735R-90-99 FXO-HC730-60-69 FXO-HC735-60-69 FXO-HC736R-100-106 FX0-HC736R57.2720 FXO-HC736R-200.00000 FXO-HC736R-25.00000 FXO-HC736R-15 FXO-HC735R-38.88 FXO-HC735R-60MHZ

Renesas Electronics:

FXO-HC735-24.576 FXOHC736R-15